

## SN74AC14-Q1 ヘキサ・シュミット・トリガ・インバータ

### 1 特長

- 車載アプリケーション向け認定済み
- 2V~6V の  $V_{CC}$  で動作
- 6V までの入力電圧に対応

### 2 概要

このシュミット・トリガ・デバイスには、6 つの独立したインバータがあります。これらのデバイスは、ブール関数  $Y = \bar{A}$  を実行します。

#### パッケージ情報

部品番号	パッケージ <sup>1</sup>	本体サイズ (公称)
SN74AC14-Q1	PW (TSSOP, 14)	5.00mm × 4.4mm

1. 利用可能なパッケージについては、データシートの末尾にある注文情報を参照してください。



図 2-1. 各コンバータの論理図 (正論理)



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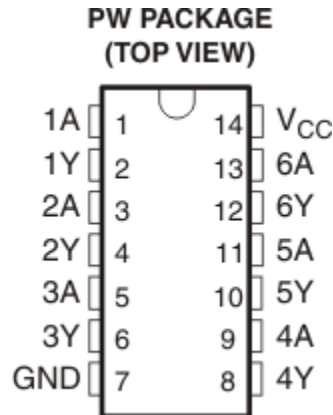
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### 3 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

<b>Changes from Revision * (June 2011) to Revision A (May 2023)</b>	<b>Page</b>
• 「パッケージ情報」表、「ピン機能」表、「熱に関する情報」表を追加 .....	<b>1</b>

## 4 Pin Configuration and Functions



NAME	PIN		I/O	DESCRIPTION
	D, DB, N, NS, PW, J, or W	FK		
1A	1	2	Input	Channel 1, Input A
1Y	2	3	Output	Channel 1, Output Y
2A	3	4	Input	Channel 2, Input A
2Y	4	6	Output	Channel 2, Output Y
3A	5	8	Input	Channel 3, Input A
3Y	6	9	Output	Channel 3, Output Y
GND	7	10	—	Ground
4Y	8	12	Output	Channel 4, Output Y
4A	9	13	Input	Channel 4, Input A
5Y	10	14	Output	Channel 5, Output Y
5A	11	16	Input	Channel 5, Input A
6Y	12	18	Output	Channel 6, Output Y
6A	13	19	Input	Channel 6, Input A
V <sub>CC</sub>	14	20	—	Positive Supply
NC		1, 5, 7, 11, 15, 17	—	Not internally connected

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted<sup>(1)</sup>)

		MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range	-0.5	7	V
V <sub>I</sub> <sup>(2)</sup>	Input voltage range	-0.5	V <sub>CC</sub> + 0.5	V
V <sub>O</sub> <sup>(2)</sup>	Output voltage range	-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	Input clamp current	(V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> )		±20 mA
I <sub>OK</sub>	Output clamp current	(V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )		±20 mA
I <sub>O</sub>	Continuous output current	(V <sub>O</sub> = 0 to V <sub>CC</sub> )		±50 mA
	Continuous current through V <sub>CC</sub> or GND			±200 mA
T <sub>stg</sub>	Storage temperature range	-65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 5.2 Recommend Operating Conditions

see [Note 1](#)

		MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage	2	6	V
V <sub>I</sub>	Input voltage	0	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage	0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 3 V		-12 mA
		V <sub>CC</sub> = 4.5 V		-24
		V <sub>CC</sub> = 5.5 V		-24
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 3 V		12 mA
		V <sub>CC</sub> = 4.5 V		24
		V <sub>CC</sub> = 5.5 V		24
T <sub>A</sub>	Operating free-air temperature	-40	125	°C

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number [SCBA004](#).

### 5.3 Thermal Information

THERMAL METRIC <sup>(1)</sup>	SN74AC14-Q1	UNIT
	PW (TSSOP)	
	14 PINS	
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	113 °C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 5.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
V <sub>T+</sub> Positive-going threshold		3 V	0.8	1.8	2.2	0.8	2.2	V
		4.5 V	1.5	2.6	3.2	1.5	3.2	
		5.5 V	1.6	3.2	3.9	1.6	3.9	
V <sub>T-</sub> Negative-going threshold		3 V	0.5	0.8	1	0.5	1.2	V
		4.5 V	0.9	1.4	1.8	0.9	1.8	
		5.5 V	1.1	1.8	2.3	1.1	2.3	
ΔV <sub>T</sub> Hysteresis (V <sub>T+</sub> - V <sub>T-</sub> )		3 V	0.3	1	1.2	0.3	1.2	V
		4.5 V	0.4	1.2	1.4	0.4	1.4	
		5.5 V	0.5	1.4	1.6	0.5	1.6	
V <sub>OH</sub>	I <sub>OH</sub> = -50 μA	3 V	2.9			2.9		V
		4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
	I <sub>OH</sub> = -12 mA	3 V	2.56			2.4		
		4.5 V	3.86			3.7		
		5.5 V	4.86			4.7		
V <sub>OL</sub>	I <sub>OL</sub> = 50 μA	3 V	0.1			0.1		V
		4.5 V	0.1			0.1		
		5.5 V	0.1			0.1		
	I <sub>OL</sub> = 12 mA	3 V	0.36			0.5		
		4.5 V	0.36			0.5		
		5.5 V	0.36			0.5		
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V	±0.1			±1		μA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V	2			40		μA
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V	4.5					pF

## 5.5 Switching Characteristics, V<sub>CC</sub> = 5 V ± 0.5 V

over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
t <sub>PLH</sub>	A	Y	1.5	5	10	1.5	12	ns
t <sub>PHL</sub>			1.5	5	8.5	1.5	10	

## 5.6 Switching Characteristics, V<sub>CC</sub> = 3.3 V ± 0.3 V

over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			MIN	MAX	UNIT
			MIN	TYP	MAX			
t <sub>PLH</sub>	A	Y	1.5	6	13.5	1.0	16	ns
t <sub>PHL</sub>			1.5	6	11.5	1.0	14	

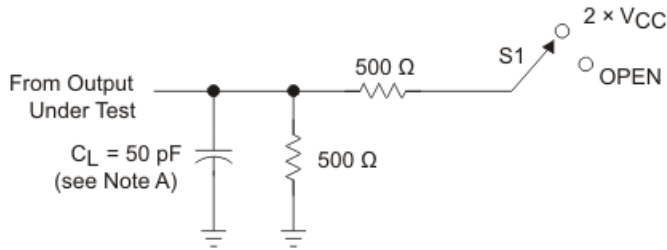
## 5.7 Operating Characteristics

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

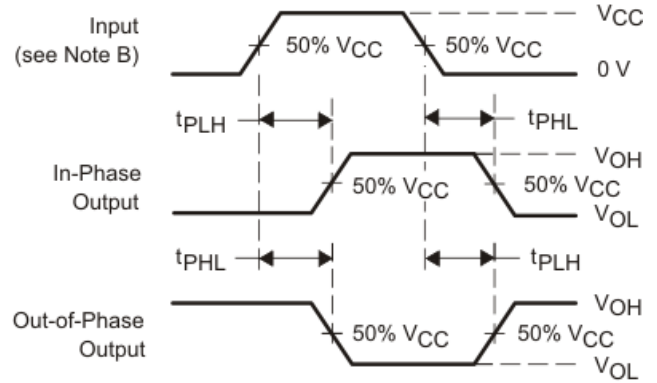
PARAMETER		TEST CONDITIONS	TYP	UNIT
$C_{pd}$	Power dissipation capacitance	$C_L = 50\text{ pF}$ , $f = 1\text{ MHz}$	30	pF

## 6 Parameter Measurement Information

TEST	S1
$t_{PLH}/t_{PHL}$	Open



**LOAD CIRCUIT**



**VOLTAGE WAVEFORMS**

- A. C<sub>L</sub> includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z<sub>O</sub> = 50 Ω, t<sub>r</sub> ≤ 2.5 ns, t<sub>f</sub> ≤ 2.5 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

**6-1. Load Circuit and Voltage Waveforms**



## 7 Detailed Description


### 7.1 Overview

This Schmitt-trigger device contains six independent inverters. They perform the Boolean function  $Y = \overline{A}$ . Because of the Schmitt action, they have different input threshold levels for positive-going ( $V_{T+}$ ) and for negative-going ( $V_{T-}$ ) signals.

These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean, jitter-free output signals. They also have a greater noise margin than conventional inverters.

### 7.2 Functional Block Diagram




**7-1. Logic Diagram  
Each Inverter (Positive Logic)**

### 7.3 Device Functional Modes

**表 7-1. Function Table**

INPUT	OUTPUT
<b>A</b>	<b>Y</b>
H	L
L	H

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AC14QPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	AC14Q	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN74AC14-Q1 :**

- Catalog : [SN74AC14](#)
- Military : [SN54AC14](#)

NOTE: Qualified Version Definitions:

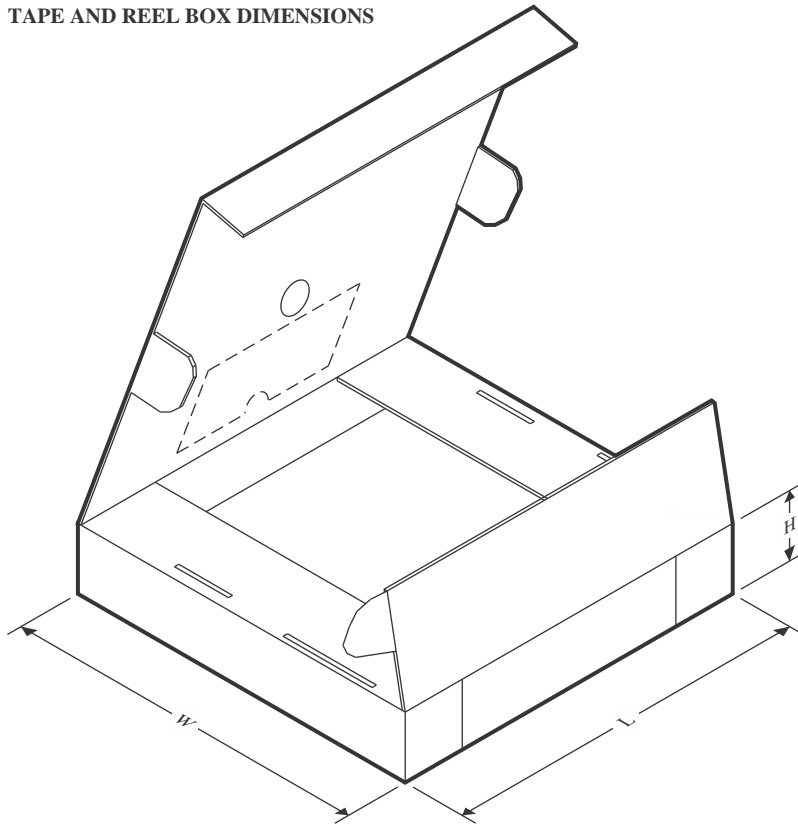
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AC14QPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74AC14QPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0



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